GaAs MMICs Panasonic

GN05013N

GaAs IC

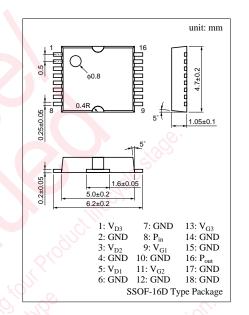
Transmitting amplifier for PHS

■ Features

- Operated by a single positive power supply
- Low consumption current
- Input/output 50Ω matching

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit	
Power supply voltage	V _{DD}	5	V	
Input current	P _{in}	-15	dBm	
Allowable power dissipation	P _D	400	mW	
Operating temperature	Topr	-10 to +60	°C	
Storage temperature	T _{stg}	-30 to +120	°C	



■ Electrical Characteristics $(V_{DD} = 3V, Ta = 25 \pm 3^{\circ}C)$

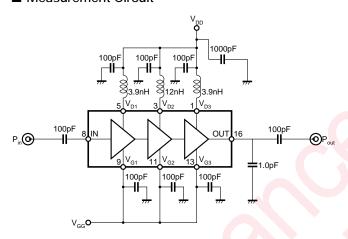
Parameter	Symbol	Conditions	min	typ	max	Unit
Circuit current	I_{DD}	$V_{GS} = 0$ to $+0.5V$	10, 10	145	165	mA
Power gain	PG*1	$V_{GS} = 0 \text{ to } +0.5 \text{V}$	34	40		dB
		$f = 1906.5MHz, P_{out} = 20.5dBm$				
	\bigcirc	$V_{GS} = 0$ to +0.5V, $f = 1906.5MHz$	100			
	DM ₁ *1	$P_{out} = 20.5 dBm$		-60	-55	dBc
Adjacent channel leakage		600kHz Detuning, 192kHz Bandwidth				
power (ACP)	DM ₂ *1	$V_{GS} = 0$ to +0.5V, $f = 1906.5MHz$			-60	dBc
		$P_{out} = 20.5 dBm$	-68	-68		
		900kHz Detuning, 192kHz Bandwidth		<u> </u>		
Voltage standing wave ratio VS	VSWRin*1	$V_{GS} = 0$ to +0.5V, $f = 1906.5MHz$		2.5	3	_
	VSWKIII	$P_{out} = 20.5 dBm$		2.3		
Harmonics output ratio	2fo*1	$V_{GS} = 0$ to +0.5V, $f = 1906.5MHz$	-30	-25	dBc	
		$P_{out} = 20.5 dBm$		-30	-23	

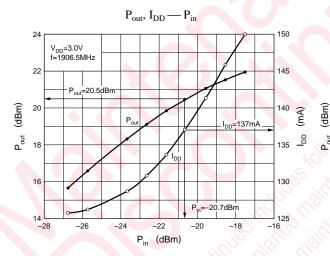
 $^{^{*1}}$ Gate voltage (V_{GS}) is the voltage which adjusts the drain current (I_D) to 125mA under no input signal condition.

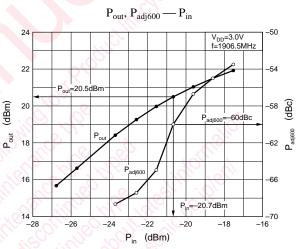
^{**} In case of handling this IC, take measures against static electricity.

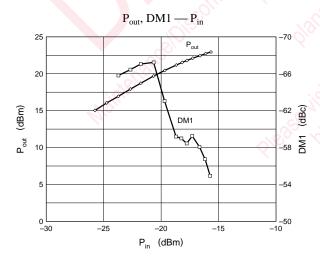
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■ Measurement Circuit











■ This product contains Gallium Arsenide (GaAs).

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